Technical Data Sheet

BADAMID® | PPA-HP2 GF60 H S3

PPA+PA-GF60

Heat-stabilized and 60% glass fibre reinforced injection moulding grade based on a polyamide blend; manufacturing without ADN and PA66

Properties	Test conditions	Test method	Unit	dry as molded	conditioned 23 °C, 50 % r.F.
Mechanical Properties					
Tensile Modulus	23°C, 1 mm/Min	ISO 527-1/2	MPa	21600	19500
Tensile Strength at yield	23°C, 50 mm/Min	ISO 527-1/2	MPa	-	-
Tensile strain at yield	23°C, 50 mm/Min	ISO 527-1/2	%	-	-
Nominal strain at break	23°C, 50 mm/Min	ISO 527-1/2	%	-	-
Tensile stress at break	23°C, 5 mm/Min	ISO 527-1/2	MPa	255	215
Tensile strain at break	23°C, 5 mm/Min	ISO 527-1/2	%	2.3	2.7
Flexural Modulus	23°C	ISO 178	MPa	-	-
Flexural Strength	23°C	ISO 178	MPa	-	-
Charpy Impact Strength	23°C -30°C	ISO 179/1eU ISO 179/1eU	kJ/m² kJ/m²	90 -	110
Charpy Notched Impact Strength	23°C -30°C	ISO 179/1eA ISO 179/1eA	kJ/m² kJ/m²	15 -	19
Izod Notched Impact Strength	23°C -30°C	ISO 180/1A ISO 180/1A	kJ/m² kJ/m²	- -	-
Ball indentation hardness	358 N	ISO 2039-1	MPa	-	-
Thermal Properties					
Melting temperature	10 K/min	ISO 3146	°C	-	
Temperature of deflection under load	0,45 MPa 1,8 MPa 8 MPa	ISO 75-1/2 ISO 75-1/2 ISO 75-1/2	°C °C °C	240 200 -	
Coefficient of linear thermal expansion	parallel across	ISO 11359-2 ISO 11359-2	E-4/K E-4/K	- -	
Thermal conductivity	Test plate 2 mm	DIN 52612-1	W/(m*K)	-	
Maximum service temperature (50% decrease in tensile strength)	some hours 20.000 h	IEC-60216 IEC-60216	°C °C	255 120	
Flammability		UL94 UL94 UL94 UL94	Wall thickness mm Rating Wall thickness mm Rating	0.8 HB 1.6 HB	
Glow wire test GWIT		IEC-60695-2-13 IEC-60695-2-13 IEC-60695-2-13 IEC-60695-2-13	Wall thickness mm Temperature °C Wall thickness mm Temperature °C	- - - -	
Glow wire test GWFI		IEC-60695-2-12 IEC-60695-2-12 IEC-60695-2-12 IEC-60695-2-12	Wall thickness mm Temperature °C Wall thickness mm Temperature °C	- - - -	
Electrical Properties					
Relative Permittivity	1 MHz	IEC-62631-2-1	-	-	-
Dissipation Factor	1 MHz	IEC-62631-2-1	E-4	-	-
Spec. Volume Resistivity	-	IEC-62631-3-1	Ohm*cm	10E13	-

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Spec. Surface Resistivity	-	IEC-62631-3-2	Ohm	10E14	-
Dielectric Strength	-	IEC-60243-1	kV/mm	-	-
Comparative Tracking Index (CTI)	-	IEC-60112	V	600	-
Other Data					
Water absorption	23°C, Saturation	ISO 62	%	2.5	
Moisture absorption	23°C, 50% r.h.	ISO 62	%	0.7	
Density	23°C	ISO 1183	g/cm³	1.70	
Melt Volume Rate (MVR) 	Value Temperature Test Load	ISO 1133 ISO 1133 ISO 1133	cm³/10min °C kg	- - -	
Viscosity number	0,5% in 96% H2SO4	ISO 307	cm³/g	-	
Processing injection molding					
Melt temperature			°C	280 - 300	
Mold temperature			°C	80 - 120	
Guide Value Moisture			%	< 0.05	
Drying temperature			°C	120	
Guide Value Drying time			h	2 - 4	

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